V20PL60-M3

Vishay General Semiconductor

High Current Density Surface Mount Trench MOS Barrier Schottky Rectifier

Ultra Low $V_F = 0.29$ V at $I_F = 5$ A



TO-277A (SMPC)

20 A

60 V

240 A

0.46 V

150 °C

TO-277A (SMPC)

Single die

PRIMARY CHARACTERISTICS

I_{F(AV)} V_{RRM}

 I_{FSM}

 V_F at $I_F = 20 \text{ A} (T_A = 125 \text{ °C})$

T_J max.

Package

Diode variation

FEATURES

- Very low profile typical height of 1.1 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in low voltage high frequency DC/DC converters, freewheeling, and polarity protection applications.

MECHANICAL DATA

Case: TO-277A (SMPC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test

| MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted) | | | | |
|--|-----------------------------------|-------------|------|--|
| PARAMETER | SYMBOL | V20PL60 | UNIT | |
| Device marking code | | 20L6 | | |
| Maximum repetitive peak reverse voltage | V _{RRM} | 60 | V | |
| Maximum average forward rectified current (fig. 1) | I _F ⁽¹⁾ | 20 | A | |
| | I _F ⁽²⁾ | 5.5 | | |
| Maximum DC reverse voltage | V _{DC} | 45 | V | |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | I _{FSM} | 240 | А | |
| Operating junction and storage temperature range | T _J , T _{STG} | -40 to +150 | °C | |

Notes

(1) Mounted on 30 mm x 30 mm pad areas aluminum PCB

⁽²⁾ Free air, mounted on recommended copper pad area



ROHS COMPLIANT



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| ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | |
|--|--|-------------------------|-------------------------------|-------|------|------|
| PARAMETER | TEST CONDITIONS | | SYMBOL | TYP. | MAX. | UNIT |
| Instantaneous forward voltage | $I_{F} = 5.0 \text{ A}$ | T _A = 25 °C | - V _F (1) | 0.40 | - | V |
| | I _F = 10 A | | | 0.45 | - | |
| | I _F = 20 A | | | 0.51 | 0.59 | |
| | I _F = 5.0 A | T _A = 125 °C | | 0.29 | - | |
| | I _F = 10 A | | | 0.36 | - | |
| | I _F = 20 A | | | 0.46 | 0.54 | |
| Reverse current | V _B = 45 V | T _A = 25 °C | | 0.025 | - | mA |
| | $v_{\rm R} = 43 v$ | T _A = 125 °C | I _R ⁽²⁾ | 17 | - | |
| | $V_{R} = 60 V$ $T_{A} = 25 °C$ $T_{A} = 125 °C$ | T _A = 25 °C | 'R (=/ | - | 4 | mA |
| | | | 35 | 100 | mA | |

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: pulse width \leq 5 ms

| THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted) | | | | |
|--|---------------------------------|---------|------|--|
| PARAMETER | SYMBOL | V20PL60 | UNIT | |
| Typical thermal resistance | R _{0JA} (1)(2) | 68 | °C/W | |
| | R _{0JM} ⁽³⁾ | 4 | | |

Notes

 $^{(1)}$ Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ - junction to ambient

 $^{(2)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: dP_D/dT_J < 1/R_{0JA}

⁽³⁾ Mounted on 30 mm x 30 mm 2 oz. pad PCB; thermal resistance R_{0JM} - junction to mount measured at cathode side

| ORDERING INFORMATION (Example) | | | | | |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|--|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE | |
| V20PL60-M3/86A | 0.10 | 86A | 1500 | 7" diameter plastic tape and reel | |
| V20PL60-M3/87A | 0.10 | 87A | 6500 | 13" diameter plastic tape and reel | |

RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

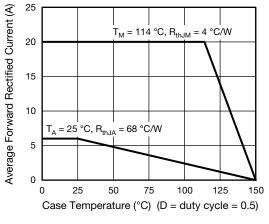


Fig. 1 - Maximum Forward Current Derating Curve

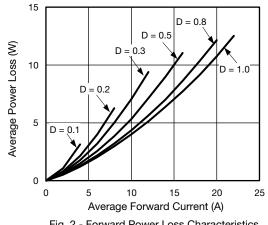


Fig. 2 - Forward Power Loss Characteristics

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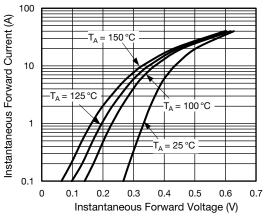


Fig. 3 - Typical Instantaneous Forward Characteristics

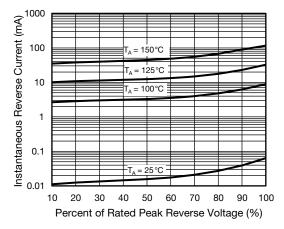


Fig. 4 - Typical Reverse Leakage Characteristics

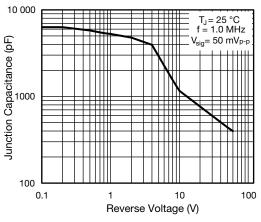


Fig. 5 - Typical Junction Capacitance

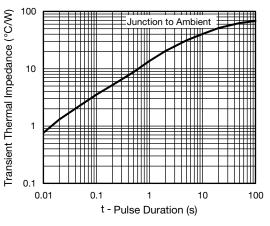
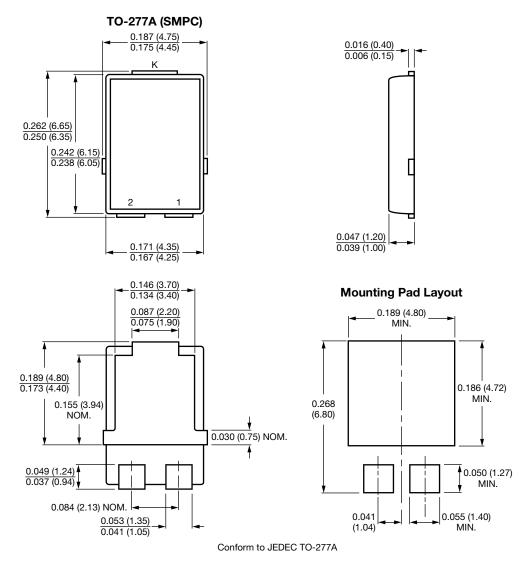


Fig. 6 - Typical Transient Thermal Impedance

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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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